APPLICAE	BLE STAN	DARD										
	Operating	$\wedge$	-55 °C +0 105 °	o <b>C</b> (1)	Stora				-10°C to 6	:∩ °C	(2)	
Ī	Temperature Ra	ange <u>/2\</u>	Signal Contact : 50 V AC			emperature Range			-10 °C to 60 °C			
rtating	Voltage		Power Contact : 200 V AC  Signal Contact : 0.5 A			orage Humidity Range			Relative humidity 85 <sup>o</sup> (Not dewed)	Relative humidity 85% max		
	Current		Power Contact : 3.0A			perating Humidity Range						
			SPEC	IFICAT	IONS	S						
ITE	EM		TEST METHOD				REC	QUIR	REMENTS	QT	АТ	
CONSTRU					l			-,			1	
General Exam		Visually a	and by measuring instrument	t.	1	Accord	ing to drav	wing.		×	×	
Marking		Confirmed visually.								×	×	
ELECTRIC	CHARACT	TERISTICS										
Contact Resistance		100 mA(DC or 1000Hz)				Signal Contact: 70m Ω MAX.				×	_	
Insulation Resistance Voltage Proof		Signal Contact : 100 V DC.				Power Contact : 20m Ω MAX.				×		
		Power Contact : 100 V DC.				Signal Contact : 100 M $\Omega$ MIN. Power Contact : 1000 M $\Omega$ MIN.				_ ^	_	
		Signal Contact : 150 V AC for 1 min.									×	
		Power Contact : 600 V AC for 1 min.				No flashover or breakdown.				×	_	
MECHANIC	CAL CHAR.	ACTERI	STICS									
Insertion and		Measured by applicable connector.				Insertion Force: 27 N MAX.				×	_	
Withdrawal Forces Mechanical Operation		400 times inserting and outresting					awal Force		3 N MIN.			
меснанса Ореганоп		100 times insertions and extractions.				<ul> <li>① Contact Resistance:</li> <li>Signal Contact: 80m Ω MAX.</li> <li>Power Contact: 30m Ω MAX.</li> <li>② No damage, crack and looseness of parts.</li> </ul>				×	_	
Vibration		Frequency 10 to 55 to 10Hz, approx 5min				<ol> <li>No damage, crack and looseness of parts.</li> <li>No electrical discontinuity of 1 μs.</li> <li>No damage, crack and looseness of parts.</li> </ol>				×	_	
		Single amplitude : 0.75 mm, 10 cycles for 3 axial directions.										
Shock			, duration of pulse 11 ms for 3 both axial directions.							×	-	
ENVIRONN	MENTAL C	HARACT	TERISTICS		ı						1	
Damp Heat		Exposed	at 40±2°C, 90 ~ 95 %	, 96 h.	(	1 Cor	ntact Resis	stance	):	×	_	
(Steady state)						Signal Contact: 80m Ω MAX.						
Rapid Change of		Temperature -55 → +85 °C				Power Contact : 30m Ω MAX.  ② Insulation Resistance:				×	_	
Temperature		Time under 5		nin.	(	_	ulation Res Signal Con		ce: 100 MΩ MIN.			
			time to chamber : within 2~3 M	1IN)		P	Power Con	tact:	1000 MΩ MIN.			
Cold		Exposed at -55°C, 96 h				<ul><li>③ No damage, crack and looseness of parts.</li><li>① Contact Resistance: Signal Contact: 80m Ω MAX.</li></ul>				×	-	
Dry Heat 2		Exposed at 105°C, 96 h				Power Contact: 80mΩ MAX.  Power Contact: 30mΩ MAX.  ② No damage, crack and looseness of parts.				×	-	
Sulfur Dioxide		Exposed at 25±2°C, 75±5%RH, 25 PPM for 96 h.				<ul><li>No damage, crack and looseness or parts.</li><li>No defect such as corrosion which impairs</li></ul>				×	<del>-</del>	
Resistance to		(Test standard: IEC 68)				the function of connector.  ② Contact Resistance: Signal Contact: 80m Ω MAX. Power Contact: 30m Ω MAX.  No deformation of case of excessive						
										×	<del>  -</del>	
Soldering Heat		Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec				looseness of the terminal.						
			ng irons : 360°C MAX. for 5	sec.								
Solderability		Soldered at solder temperature 240±3°C for immersion duration, 3 sec.			r	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.				×	-	
COUNT	T D	DESCRIPTION OF REVISIONS DESIGNATION DE LA CONTRA DE				<u> </u>				L^	TE	
/2\ 2	ı DE				TS. 00				HT. YAMAGUCHI		2. 01	
	1	DIS-F-00002057 TS			13.00	APPROVED CHECKED		ED				
VEINIYKV9 ()	) Include tempera		s a long-term storage state for the unused product						KN. SHIBUYA	14.09.0		
NEIVIARNO (1	<sup>2)</sup> "STORAGE" me	ans a long-te	erm storage state for the unused pro			DESIGNED			14. 09. 02 14. 09. 02			
NEIVIARNO (1 (2)	<sup>1)</sup> Include tempera <sup>2)</sup> "STORAGE" me before assembl	ans a long-te	erm storage state for the unused pro					FD				
(2)	<sup>2)</sup> "STORAGE" me before assembly	eans a long-te y to PCB.					DESIGNE		TS. 00N0	14. 0	9. 02	
Unless othe	erwise specif	eans a long-te y to PCB. Fied, refer	to IEC 60512.		DR	AWIN				14. 0 14. 0	9. 02	
Unless othe	2) "STORAGE" me before assembly erwise specification Tes	eans a long-te y to PCB. Fied, refer at AT:Ass	to IEC 60512.	est	DR PART		DESIGNE DRAWN	N	TS. 00N0 TS. 00N0	14. 0 14. 0	9. 02	